

INTERNATIONAL STANDARD

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**Industrial communication networks – Profiles –
Part 2: Additional fieldbus profiles for real-time networks based on
ISO/IEC 8802-3**

**Réseaux de communication industriels – Profils –
Partie 2: Profils supplémentaires des bus de terrain pour les réseaux temps
réel basés sur l'ISO/CEI 8802-3**



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CONTENTS

FOREWORD.....	11
INTRODUCTION.....	13
1 Scope.....	14
2 Normative references	14
3 Terms, definitions, abbreviated terms, acronyms, and conventions.....	17
3.1 Terms and definitions	17
3.2 Abbreviated terms and acronyms	20
3.3 Symbols	22
3.3.1 CPF 2 symbols	22
3.3.2 CPF 3 symbols	23
3.3.3 CPF 4 symbols	24
3.3.4 CPF 6 symbols	24
3.3.5 CPF 10 symbols	25
3.3.6 CPF 11 symbols	26
3.3.7 CPF 12 symbols	27
3.3.8 CPF 13 symbols	27
3.3.9 CPF 14 symbols	28
3.3.10 CPF 15 symbols	29
3.3.11 CPF 16 symbols	29
3.4 Conventions	30
3.4.1 Conventions common to all layers	30
3.4.2 Physical Layer	31
3.4.3 Data Link Layer	31
3.4.4 Application Layer	32
4 Conformance to communication profiles	32
5 RTE performance indicators	33
5.1 Basic principles of performance indicators	33
5.2 Application requirements	34
5.3 Performance indicators.....	34
5.3.1 Delivery time	34
5.3.2 Number of RTE end-stations.....	35
5.3.3 Basic network topology.....	35
5.3.4 Number of switches between RTE end-stations	35
5.3.5 Throughput RTE	35
5.3.6 Non-RTE bandwidth	35
5.3.7 Time synchronization accuracy.....	35
5.3.8 Non-time-based synchronization accuracy.....	36
5.3.9 Redundancy recovery time	36
6 Conformance tests	36
6.1 Concept	36
6.2 Methodology.....	37
6.3 Test conditions and test cases	37
6.4 Test procedure and measuring	38
6.5 Test report	38
7 Communication Profile Family 2 (CIP™) – RTE communication profiles.....	39

7.1	General overview	39
7.2	Profile 2/2	39
7.2.1	Physical Layer	39
7.2.2	Data Link Layer	39
7.2.3	Application Layer	39
7.2.4	Performance indicator selection	39
7.3	Profile 2/2.1	43
7.3.1	Physical Layer	43
7.3.2	Data Link Layer	44
7.3.3	Application Layer	45
7.3.4	Performance indicator selection	46
8	Communication Profile Family 3 (PROFIBUS & PROFINET) – RTE communication profiles	49
8.1	General overview	49
8.1.1	CPF 3 overview	49
8.1.2	Node Classes	49
8.1.3	Application classes	51
8.1.4	Communication classes	51
8.1.5	Redundancy classes	51
8.1.6	Media classes	52
8.1.7	Conformance class behaviors	52
8.2	Profile 3/4	55
8.2.1	Physical layer	55
8.2.2	Data link layer	55
8.2.3	Application layer	56
8.2.4	Performance indicator selection	61
8.3	Profile 3/5	68
8.3.1	Physical layer	68
8.3.2	Data link layer	68
8.3.3	Application layer	69
8.3.4	Performance indicator selection	73
8.4	Profile 3/6	75
8.4.1	Physical layer	75
8.4.2	Data link layer	75
8.4.3	Application layer	76
8.4.4	Performance indicator selection	81
9	Communication Profile Family 4 (P-NET) – RTE communication profiles	83
9.1	General overview	83
9.2	Profile 4/3, P-NET on IP	83
9.2.1	Physical Layer	83
9.2.2	Data Link Layer	83
9.2.3	Application Layer	84
9.2.4	Performance indicator selection	85
10	Communication Profile Family 6 (INTERBUS®) – RTE communication profiles	89
10.1	General overview	89
10.2	Profile 6/4	90
10.2.1	Mapping	90
10.2.2	Type 10 service and protocol selection	91
10.2.3	Type 8 service and protocol selection	92

10.2.4	Performance indicator selection	92
10.3	Profile 6/5	93
10.3.1	Mapping	93
10.3.2	Type 10 service and protocol selection	93
10.3.3	Type 8 service and protocol selection	93
10.3.4	Performance indicator selection	94
10.4	Profile 6/6	94
10.4.1	Mapping	94
10.4.2	Type 10 service and protocol selection	94
10.4.3	Type 8 service and protocol selection	95
10.4.4	Performance indicator selection	95
11	Communication Profile Family 10 (Vnet/IP) – RTE communication profiles	96
11.1	General overview	96
11.2	Profile 10/1	97
11.2.1	Physical Layer	97
11.2.2	Data Link Layer	97
11.2.3	Application Layer	99
11.2.4	Performance indicator selection	100
12	Communication Profile Family 11 (TCnet) – RTE communication profiles	106
12.1	General overview	106
12.2	Profile 11/1	106
12.2.1	Physical Layer	106
12.2.2	Data Link Layer	106
12.2.3	Application Layer	107
12.2.4	Performance indicator selection	108
13	Communication Profile Family 12 (EtherCAT) – RTE communication profiles	114
13.1	General overview	114
13.2	Profile CP 12/1	114
13.2.1	Physical Layer	114
13.2.2	Data Link Layer	115
13.2.3	Application Layer	119
13.2.4	Performance indicator selection	121
13.3	Profile CP 12/2	124
13.3.1	Physical Layer	124
13.3.2	Data Link Layer	124
13.3.3	Application Layer	128
13.3.4	Performance indicator selection	130
14	Communication Profile Family 13 (ETHERNET Powerlink) – RTE communication profiles	133
14.1	General overview	133
14.2	Profile 13/1	133
14.2.1	Physical Layer	133
14.2.2	Data Link Layer	133
14.2.3	Application Layer	134
14.2.4	Performance indicator selection	134
15	Communication Profile Family 14 (EPA)- RTE communication profiles	140
15.1	General overview	140
15.2	CPF 14 (EPA) communication concept	140

15.2.1	General	140
15.2.2	Network Topology	140
15.2.3	EPA devices	141
15.3	Profile 14/1	142
15.3.1	Physical Layer	142
15.3.2	Data Link Layer	142
15.3.3	Network Layer	142
15.3.4	Transport Layer	142
15.3.5	Application Layer	142
15.3.6	Performance indicator selection	144
15.4	Profile 14/2	147
15.4.1	Physical Layer	147
15.4.2	Data Link Layer	147
15.4.3	Network Layer	147
15.4.4	Transport Layer	148
15.4.5	Application Layer	148
15.4.6	Performance indicator selection	149
16	Communication Profile Family 15 (MODBUS-RTPS)- RTE communication profiles	153
16.1	General overview	153
16.2	Profile 15/1	153
16.2.1	Physical layer	153
16.2.2	Data link layer	153
16.2.3	Application layer	153
16.2.4	Performance indicator selection	154
16.3	Profile 15/2	158
16.3.1	Physical layer	158
16.3.2	Data link layer	158
16.3.3	Application layer	158
16.3.4	Performance indicator selection	159
17	Communication Profile Family 16 (SERCOS)- RTE communication profiles	164
17.1	General overview	164
17.2	Profile 16/3 (SERCOS III)	164
17.2.1	Physical Layer	164
17.2.2	Data Link Layer	164
17.2.3	Application Layer	165
17.2.4	Performance indicator selection	165
Annex A	(informative) Performance Indicator calculation	172
A.1	CPF 2 (CIP) – Performance indicator calculation	172
A.1.1	Profile 2/2 EtherNet/IP	172
A.1.2	Profile 2/2.1 EtherNet/IP with Time Synchronization	173
A.2	Communication Profile Family 3 – Performance indicator calculation	174
A.2.1	Application Scenario	174
A.2.2	Structural examples used for calculation	174
A.2.3	Principles used for calculation	179
A.3	CPF 4/3 P-NET on IP – Performance indicator calculation	182
A.3.1	Application scenario	182
A.3.2	Delivery time calculation	182
A.3.3	Non-RTE throughput calculation	183

A.3.4	Non time-base synchronization accuracy	185
A.3.5	RTE throughput calculation.....	186
A.3.6	CPF 4/3, Derivation of delivery time formula	186
A.3.7	CPF 4/3, Ethernet characteristics	188
Bibliography.....		189
Figure 1	– Example of graphical representation of consistent indicators	34
Figure 2	– Conformance test overview	36
Figure 3	– Example of network topology using CP 3/4, CP 3/5, and CP 3/6 components	55
Figure 4	– Example of network topology with wireless segment	58
Figure 5	– Calculation basis for delivery time and throughput RTE.....	64
Figure 6	– Linking-device communication profiles RTE-network context.....	89
Figure 7	– Linking-device mapping principle	90
Figure 8	– Data Mapping.....	91
Figure 9	– Throughput RTE and non-RTE bandwidth	111
Figure 10	– EPA system network topology example.....	141
Figure A.1	– CP 3/4: Example of line structure.....	174
Figure A.2	– CP 3/4: Example of ring structure	174
Figure A.3	– CP 3/4: Example of a wireless segment.....	175
Figure A.4	– CP 3/4: Example of an integrated wireless client.....	175
Figure A.5	– CP 3/5: Example of line structure.....	176
Figure A.6	– CP 3/5: Example of ring structure	176
Figure A.7	– CP 3/6: Example of line structure.....	177
Figure A.8	– CP 3/6: Example of ring structure	178
Figure A.9	– CP 3/6: Example of tree structure	179
Figure A.10	– Definition of bridge delay	180
Figure A.11	– Example of a switch structure	181
Figure A.12	– Application Configuration	182
Figure A.13	– Non-RTE throughput calculation	184
Figure A.14	– Non time-base synchronization accuracy	185
Table 1	– Layout of profile (sub)clause selection tables	30
Table 2	– Contents of (sub)clause selection tables	30
Table 3	– Layout of service selection tables.....	30
Table 4	– Contents of service selection tables	31
Table 5	– Layout of parameter selection tables	31
Table 6	– Contents of parameter selection tables	31
Table 7	– Layout of class attribute selection tables	32
Table 8	– Contents of class attribute selection tables.....	32
Table 9	– Basic network topology types	35
Table 10	– CP 2/2: performance indicator overview	40
Table 11	– CP 2/2: Performance indicator dependency matrix	40
Table 12	– CP 2/2: consistent set of performance indicators for factory automation	43

Table 13 – CP 2/2.1: DLL protocol selection	44
Table 14 – CP 2/2.1: DLL protocol selection of management objects	44
Table 15 – CP 2/2.1: AL service selection.....	45
Table 16 – CP 2/2.1: AL protocol selection	46
Table 17 – CP 2/2.1: performance indicator overview	47
Table 18 – CP 2/2.1: performance indicator dependency matrix	47
Table 19 – CP 2/2.1: Consistent set of performance indicators for motion control	48
Table 20 – Timeout values for name resolution	50
Table 21 – Reaction time for an IO device	50
Table 22 – Redundancy class applicable in conformance classes	52
Table 23 – Conformance class behaviors.....	52
Table 24 – Conformance class behaviors for network components.....	54
Table 25 – CP 3/4: AL service selection for an IO device	56
Table 26 – CP 3/4: AL protocol selection for an IO device and Network component	59
Table 27 – CP 3/4: AL protocol selection for an IO controller	60
Table 28 – CP 3/4, CP 3/5 and CP 3/6: performance indicator overview	61
Table 29 – CP 3/4, CP 3/5 and CP 3/6: performance indicator dependency matrix	62
Table 30 – Manager parameters	65
Table 31 – Client parameters	66
Table 32 – Client parameters	66
Table 33 – CP 3/4: Consistent set of PI for MinDeviceInterval=128ms	67
Table 34 – CP 3/4: Assumed values for consistent set of PI calculation	68
Table 35 – CP 3/5: AL service selection for an IO device	69
Table 36 – CP 3/5: AL protocol selection for an IO device and Network component	71
Table 37 – CP 3/5: AL protocol selection for an IO controller	72
Table 38 – CP 3/5: Consistent set of PI for MinDeviceInterval=128ms	74
Table 39 – CP 3/5: Assumed values for consistent set of PI calculation	75
Table 40 – CP 3/6: AL service selection for an IO device	76
Table 41 – Buffering capacity.....	77
Table 42 – CP 3/6: AL protocol selection for an IO device and network component.....	78
Table 43 – CP 3/6: AL protocol selection for an IO controller	80
Table 44 – CP 3/6: Consistent set of PI for MinDeviceInterval=1ms	81
Table 45 – CP 3/6: Assumed values for consistent set of PI calculation	82
Table 46 – CP 4/3: DLL service selection.....	84
Table 47 – CP 4/3: DLL protocol selection	84
Table 48 – CP 4/3: AL service selection.....	84
Table 49 – CP 4/3: AL protocol selection	85
Table 50 – CP 4/3: Performance indicator overview	85
Table 51 – CP 4/3: Performance indicator dependency matrix	85
Table 52 – CP 4/3: Consistent set of performance indicators	88
Table 53 – Parameters for Calculation of Consistent set of performance indicators.....	88
Table 54 – CPF 6: device CP identifier assignment.....	90
Table 55 – Linking-device Type 10 network performance indicator overview	92

Table 56 – OSI layers and CPF 10 layers	96
Table 57 – Overview of CPF 10 profile	97
Table 58 – CP 10/1: DLL service selection	98
Table 59 – CP 10/1: DLL protocol selection	98
Table 60 – Transport Layer Parameter selection	99
Table 61 – CP 10/1: AL service selection	100
Table 62 – CP 10/1: AL protocol selection	100
Table 63 – CP 10/1: Performance indicator overview	100
Table 64 – CP 10/1: Performance indicator dependency matrix	101
Table 65 – CP 10/1: Consistent set of performance indicators for the communication between two end-stations belonging to the same domain	104
Table 66 – CP 10/1: Consistent set of performance indicators for the communication between two end-stations belonging to different domains	104
Table 67 – CP 10/1: Consistent set of performance indicators for the communication between two end-stations belonging to the same domain with one lost frame	105
Table 68 – CP 10/1: Consistent set of performance indicators for the communication between two end-stations belonging to different domains with one lost frame	105
Table 69 – CPF 11: Overview of profile sets	106
Table 70 – CP 11/1: DLL service selection	107
Table 71 – CP 11/1: DLL protocol selection	107
Table 72 – CP 11/1: AL service selection	108
Table 73 – CP 11/1: AL protocol selection	108
Table 74 – CP 11/1: Performance indicator overview	108
Table 75 – CP 11/1: Performance indicator dependency matrix	109
Table 76 – CP 11/1: TCC data service selection	110
Table 77 – CP 11/1: Consistent set of PIs preferential for RTE communications	113
Table 78 – CP 11/1: Consistent set of PIs both for RTE and non-RTE communications	113
Table 79 – CP 12/1: PhL selection of preferred physical layer	115
Table 80 – CP 12/1: PhL selection of an optimized physical layer	115
Table 81 – CP 12/1: DLL service selection	116
Table 82 – CP 12/1: DLL protocol selection	117
Table 83 – CP 12/1: DLL service selection	118
Table 84 – CP 12/1: DLL protocol selection	119
Table 85 – CP 12/1: AL service selection	120
Table 86 – CP 12/1: AL protocol selection	120
Table 87 – CP 12/1: AL service selection	121
Table 88 – CP 12/1: AL protocol selection	121
Table 89 – CP 12/1: Performance indicator overview	122
Table 90 – CP 12/1: Performance indicator dependency matrix	122
Table 91 – CP 12/1: Performance indicator ranges	123
Table 92 – CP 12/1: Consistent set of performance indicators for mid size automation systems	124
Table 93 – CP 12/2: DLL service selection	125
Table 94 – CP 12/2: DLL protocol selection	126
Table 95 – CP 12/2: DLL service selection	127

Table 96 – CP 12/2: DLL protocol selection	128
Table 97 – CP 12/2: AL service selection	129
Table 98 – CP 12/2: AL protocol selection	129
Table 99 – CP 12/2: AL service selection	130
Table 100 – CP 12/2: AL protocol selection	130
Table 101 – CP 12/2: Performance indicator overview	131
Table 102 – CP 12/2: Performance indicator dependency matrix	131
Table 103 – CP 12/2: Consistent set of performance indicators	132
Table 104 – CPF 13: Overview of profile sets	133
Table 105 – CP 13/1: DLL service selection	133
Table 106 – CP 13/1: DLL protocol selection	134
Table 107 – CP 13/1: AL service selection	134
Table 108 – CP 13/1: AL protocol selection	134
Table 109 – CP 13/1: Performance indicator overview	135
Table 110 – CP 13/1: Performance indicator dependency matrix	135
Table 111 – CP 13/1: Consistent set of PIs small size automation system	138
Table 112 – CP 13/1: Consistent set of PIs medium size automation system	138
Table 113 – CP 13/1: Consistent set of PIs large size automation system	139
Table 114 – CP 14/1: AL service selection	143
Table 115 – CP 14/1: AL protocol selection	143
Table 116 – CP 14/1: Performance indicator overview	144
Table 117 – CP 14/1: Performance indicator dependency matrix	144
Table 118 – CP 14/1: Consistent set of performance indicators	146
Table 119 – CP 14/2: DLL service selection	147
Table 120 – CP 14/2: DLL protocol selection	147
Table 121 – CP 14/2: AL service selection	148
Table 122 – CP 14/2: AL protocol selection	149
Table 123 – CP 14/2: Performance indicator overview	149
Table 124 – CP 14/2: Performance indicator dependency matrix	150
Table 125 – CP 14/2: Consistent set of performance indicators	152
Table 126 – CP 15/1: AL service selection	153
Table 127 – CP 15/1: AL protocol selection	154
Table 128 – CP 15/1: Performance indicator overview	154
Table 129 – CP 15/1: Performance indicator dependency matrix	155
Table 130 – CP 15/2: AL service selection	159
Table 131 – CP 15/2: AL protocol selection	159
Table 132 – CP 15/2: Performance indicator overview	159
Table 133 – CP 15/2: Performance indicator dependency matrix	160
Table 134 – CP 16/3: DLL service selection	164
Table 135 – CP 16/3: DLL protocol selection	165
Table 136 – CP 16/3: AL service selection	165
Table 137 – CP 16/3: AL protocol selection	165
Table 138 – CP 16/3: Performance indicator overview	166

Table 139 – CP 16/3: Performance indicator dependency matrix.....	166
Table 140 – CP 16/3: scenario with a minimum cycle time of 31,25 μ s.....	170
Table 141 – CP 16/3: scenario with a cycle time of 500 μ s (real-time only)	170
Table 142 – CP 16/3: Scenario with a cycle time of 500 μ s (real-time and non-real-time)....	171
Table 143 – CP 16/3: scenario with non symmetrical data throughput and a cycle time of 500 μ s (real-time and non-real-time)	171

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INDUSTRIAL COMMUNICATION NETWORKS – PROFILES –

**Part 2: Additional fieldbus profiles for real-time networks
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FDIS	Report on voting
65C/469/FDIS	65C/480/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

The French version of this standard has not been voted upon.

This publication has been drafted in accordance with ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under <http://webstore.iec.ch> in the data related to the specific publication. At that date this publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

The list of all the parts of the IEC 61784 series, under the general title *Industrial communication networks – Profiles* –, can be found on the IEC web site.

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